

FUJITSU SEMICONDUCTOR LIMITED

Nomura Fudosan Shin-yokohama Bldg. 10-23, Shin-yokohama 2-Chome, Kohoku-ku Yokohama Kanagawa 222-0033, Japan http://jp.fujitsu.com/fsl/en/

For further information please contact:

North and South America FUJITSU SEMICONDUCTOR AMERICA, INC. 1250 E. Arques Avenue, M/S 333 Sunnyvale, CA 94085-5401, U.S.A. Tel: +1-408-737-5600 Fax: +1-408-737-5999 http://us.fujitsu.com/micro/

Europe

FUJITSU SEMICONDUCTOR EUROPE GmbH Pittlerstrasse 47, 63225 Langen, Germany Tel: +49-6103-690-0 Fax: +49-6103-690-122 http://emea.fujitsu.com/semiconductor/

Korea

FUJITSU SEMICONDUCTOR KOREA LTD.
902 Kosmo Tower Building, 1002 Daechi-Dong,
Gangnam-Gu, Seoul 135-280, Republic of Korea
Tel: +82-2-3484-7100 Fax: +82-2-3484-7111
http://www.fujitsu.com/kr/fsk/

Asia Pacific

FUJITSU SEMICONDUCTOR SHANGHAI CO., LTD. 30F, Kerry Parkside, 1155 Fang Dian Road, Pudong District, Shanghai 201204, China Tel: +86-21-6146-3688 Fax: +86-21-6146-3660 http://cn.fujitsu.com/fss/

FUJITSU SEMICONDUCTOR PACIFIC ASIA LTD. 2/F, Green 18 Building, Hong Kong Science Park, Shatin, N.T., Hong Kong Tel: +852-2736-3232 Fax: +852-2314-4207 http://cn.fujitsu.com/fsp/

All Rights Reserved

FUJITSÚ SEMICONDUCTOR LIMITED, its subsidiaries and affiliates (collectively, "FUJITSU SEMICONDUCTOR") reserves the right to make changes to the information contained in this document without notice. Please contact your FUJITSU SEMICONDUCTOR sales representatives before order of FUJITSU SEMICONDUCTOR device.

Information contained in this document, such as descriptions of function and application circuit examples is presented solely for reference to examples of operations and uses of FUJITSU SEMICONDUCTOR device. FUJITSU SEMICONDUCTOR disclaims any and all warranties of any kind, whether express or implied, related to such information, including, without limitation, quality, accuracy, performance, proper operation of the device or non-infringement. If you develop equipment or product incorporating the FUJITSU SEMICONDUCTOR device based on such information, you must assume any responsibility or liability arising out of or in connection with such information or any use thereof. FUJITSU SEMICONDUCTOR assumes no responsibility or liability for any damages whatsoever arising out of or in connection with such information or any use thereof.

Nothing contained in this document shall be construed as granting or conferring any right under any patents, copyrights, or any other intellectual property rights of FUJITSU SEMICONDUCTOR or any third party by license or otherwise, express or implied. FUJITSU SEMICONDUCTOR assumes no responsibility or liability for any infringement of any intellectual property rights or other rights of third parties resulting from or in connection with the information contained herein or use thereof.

The products described in this document are designed, developed and manufactured as contemplated for general use including without limitation, ordinary industrial use, general office use, personal use, and household use, but are not designed, developed and manufactured as contemplated (1) for use accompanying fatal risks or dangers that, unless extremely high levels of safety is secured, could lead directly to death, personal injury, severe physical damage or other loss (including, without limitation, use in nuclear facility, aircraft flight control system, air traffic control system, mass transport control system, medical life support system and military application), or (2) for use requiring extremely high level of reliability (including, without limitation, submersible repeater and artificial satellite). FUJITSU SEMICONDUCTOR shall not be liable for you and/or any third party for any claims or damages arising out of or in connection with above-mentioned uses of the products.

Any semiconductor devices fail or malfunction with some probability. You are responsible for providing adequate designs and safeguards against injury, damage or loss from such failures or malfunctions, by incorporating safety design measures into your facility, equipments and products such as redundancy, fire protection, and prevention of overcurrent levels and other abnormal operating conditions.

The products and technical information described in this document are subject to the Foreign Exchange and Foreign Trade Control Law of Japan, and may be subject to export or import laws or regulations in U.S. or other countries. You are responsible for ensuring compliance with such laws and regulations relating to export or re-export of the products and technical information described herein. All company names, brand names and trademarks herein are property of their respective owners.

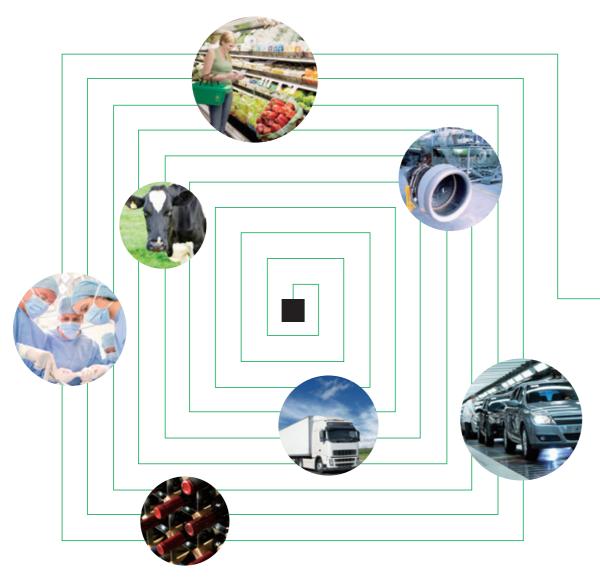
FUJITSU Semiconductor FRAM RFID LSI



Expand the Possibilities of Your RFID Tags with FRAM

Introducing Fujitsu Semiconductor's FRAM RFID LSI; "FerVID family"

FRAM ('Ferroelectric RAM') is the non-volatile memory that outperforms the conventional non-volatile memories EEPROM and Flash. Unlike EEPROM and Flash, FRAM does not require a higher internal voltage for writing operation, and this feature provides you with virtually unlimited read/write endurance, and fast writing speed. This advantage realizes large density of storage memory and stable communication distance for read and write operation. And unlike EEPROM and Flash, FRAM is resistant to sterilization by gamma-ray. Thus more and more RFID tag manufacturers around the world are selecting Fujitsu's "FerVID family" of FRAM RFID LSI as the best RFID for data carriers.



FRAM RFID Can Realize a Wider Range of RFID Applications than Ever Before

FerVID family consists of large density FRAM which are available for HF (13.56MHz) and UHF (860MHz–960MHz) applications. The feature of large density memory is perfect for RFID use in factory automation, maintenance, (asset management, and logistic tracking. And the feature of gamma-ray sterilization hardness is perfect for RFID use in the medical, pharmaceutical, biomedical, foods, and cosmetic industries. Moreover, the serial interface feature enables RFID to connect a microcontroller, and expands the possibilities of RFID into the realm of embedded applications.

arge Density Memory

Fast Writing Speed

igh Read/Write Endurand

Gamma-ray Hardness

Embedded RF

FA, Maintenance

Complete Visibility of Production and Real Time Operations

Large density memory and fast writing will improve the operational efficiency and quality of production in the factory

Because of large density memory and fast writing speed, FRAM RFID is the best solution for factory automation applications requiring frequent production data logging and efficiency of operation, and for maintenance applications requiring real time operation and on-site confirmation of maintenance history and parts information.

Production Management (Factory Automation)

The benefit of FRAM RFID tags as large density data carriers lies in their ability to store large amounts of information and to be written fast and frequently—which makes them ideal for use in production management in factories like automobile plants. The tags can record such information as production and inspection histories, customized parts and operation information, manuals, and so on. Off-line data management improves the flexibility of the production line, and shortens production lead times.













Aircraft Maintenance Management

Fujitsu's FRAM RFID has been selected for use in the maintenance of Boeing's aircraft. In order to manage the many kinds of parts in an aircraft, the RFID tags have been standardized as data carriers to keep track of maintenance history, maintenance manuals, part information, and more. This RFID solution is expected to enhance the accuracy of all Boeing aircraft maintenance, cut turnaround time, and result in much safer and more efficient aircraft management.

Great Promise as Data Carrier Tags

Because of the large density memory of FRAM RFID tags and their fast and frequent writing capability, the maintenance application fields are not just the FA and aviation

industries, but other industries as well—a partial listing of which would include: the electricity industry, the construction industry, the infrastructure, transportation (vehicle, track, road), and rental machinery industries, and the facilities management industries (gas, water, chemicals, and oil).

Medical / Pharmaceutical / Biomedical

Gamma-ray Sterilization Hardness Enables Total Traceability

Due to its resistance to gamma-ray sterilization,
FRAM RFID makes possible total traceability of medical instruments
and packages from production to waste management.

The remarkable feature of FRAM RFID for healthcare applications is strong radiation hardness, which permits RFID to be attached to products to be sterilized by gamma-ray. Unlike conventional memory used for RFID, FRAM has feature of gamma-ray sterilization hardness. This feature is great importance to the medical, pharmaceutical, and biomedical industries, which are continuously seeking to improve the safety and reliability of traceability management through the entire cycle from production and sterilization to logistics, warehousing, use in hospital, and waste.

Traceability of Products

Unlike conventional RFID tags, FRAM RFID tags can be placed on a medical or pharmaceutical product at the production stage before gamma-ray sterilization takes place from outside the package. After shipment, RFID tags can record the history of the logistic process as well. Thus, FRAM RFID enables complete visibility during all stages of the process, and thereby prevents counterfeiting. Also, when connected with sensors, FRAM RFID will be able to improve the reliability of the logistic process by recording the environmental history, such as temperature and physical stress.













Traceability in Hospitals

FRAM RFID is also expected to improve safety management and operational efficiency in hospitals. For example, the right quantity of medicines must be kept in stock at all times, and any expired medicines must be detected. The number of surgical tools must be checked before

flawless accuracy. These are some of the areas where FRAM RFID can help. Also, the penetration of NFC smart phones and tablet terminals into the medical scene may increase potential applications of FRAM RFID.



Radiation Hard Gamma-ray/E-Beam Sterilization Radiation to Blood Products

Embedded RF

Serial Interface for Creating New Value

New applications can be created by connecting FRAM RFID to microcontrollers and sensors

The serial interface feature of RFID LSI makes it possible to add value not only for simple RFID applications but also for embedded microcontroller applications. Because the FRAM is commonly accessed from both interfaces, it can be used as the storage memory for environmental monitoring data taken by sensors through a microcontroller. And FRAM can also be used for storage of microcontroller parameters, which can be changed wirelessly.

Environment Monitoring

By connecting sensors and a microcontroller to RFID through a serial interface, you can monitor the environment of the logistic process, establishing better traceability management for quality control and product safety. For example, RFID can be used to record the temperature environment during the transportation of foods and wines, or to monitor the oscillation of delicate equipment during transportation. It can also be used to monitor the status of industrial equipment and facilities like railroads, in order to detect signs of fault or need for maintenance.













Operating Parameter Setting

The key feature of RFID is that data can be read and written by R even if RFID is embedded in products and packaging. This feature creates new value for the microcontroller with which RFID is connected. In product distribution, for example, the parameter

data for individual customers can be written in FRAM even after the product is packed, and in the same way important traceability information and keys can be added during the logistic process or after arrival at the retail site. Then when the product is used for the first time, the microcontroller can load the data stored in FRAM to activate the product, or if the data is missing, the product may not be activated. Also if FRAM is used for parameter memory, the operational condition of the microcontroller can be changed by RF.



Fujitsu Semiconductor has developed an evaluation board for embedded use on which FRAM RFID is connected to a microcontroller, several sensors, and an LCD. Customers can use this board as a tool to explore new ideas and possibilities for RFID.





FerVID Family for UHF Passive RFID MB97R803A, MB97R804B, MB97R7051, MB97R8050

- ISO/IEC18000-63 (Type C), EPC C1G2 Ver.1.2.0 compliant
- Worldwide UHF frequency (860–960MHz)
- Large memory density and fast writing performance
- Stable communication distance between writing and reading (the same distance)
- Write Lock and Read Lock feature with password
- Anti-collision feature
- Serial interface for Embedded RF solutions

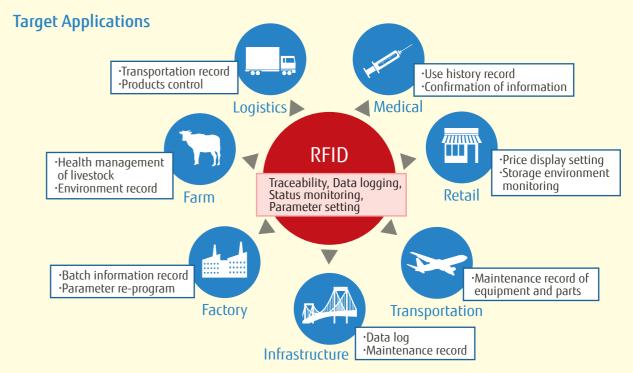
	MB97R803A	MB97R804B	MB97R7051	MB97R8050		
Memory size	4K Bytes (32K bits)		72K Bytes	36 Bytes		
User memory size	3,424 Bytes		64K Bytes	-		
Operating frequency	860-960MHz					
Modulation	DSB-ASK, SSB-ASK, PR-ASK					
Data coding	FM0, Miller Subcarrier (M=2,4,8)					
Baudrate (Reader to RFID)	40kbps-160kbps (0 data transmission)					
Baudrate (RFID to Reader)	40kbps-640kbps					
Read/write sensitivity		-12 dBm				
Command (RF)	EPC C1G2 Ver.1.2.0 commands Block Permalock, Read Lock (custom)					
Serial interface	-	SPI		-		
Serial input frequency	-	2MHz (Max)	-			
Serial input voltage	-	2.3-3.6V	-			
Command (serial)	-	Read, Write		-		
Data retention	10 years (+55℃)					
Read/Write endurance	10 ¹⁰ times					
Evaluation kit	-	Yes	-			
Shipping Form	Sawn wafer	Package TSSOP-16	Wafer, Package Thin type QFN-40	Sawn wafer		

FerVID Family for HF Passive RFID MB89R118C, MB89R119B, MB89R112A/B

- ISO/IEC15693, 18000-3/Mode1 compliant
- Large memory density and fast writing performance
- Fast reading performance with custom commands
- Outstanding gamma-ray radiation hardness
- Anti-collision feature
- High-input capacitance for antenna downsizing requirements
- Serial interface for embedded RF solutions (in development)
- Ucode tag certification by Ubiquitous ID Center

	MB89R118C	MB89R119B	MB89R112A	MB89R112B	
Memory size	2K(16K bits)	256Bytes (2,048 bits)	9K Bytes (72K bits)		
User memory size	2,000Bytes	232Bytes	8,192Bytes		
Block structure	8Bytes, 256Blocks	4Bytes, 64Blocks	32Bytes, 256Blocks		
Operating frequency	13.56MHz ± 7kHz				
Modulation	ASK10/100%				
Data coding	1 out of 4(1out of 256 is not supported)				
Sub-carrier	One sub-carrier (Two sub-carrier is not supported)				
Baudrate	26.48, 52.97kbps (Response to Fast command)				
Commands	ISO15693 commands, Custom commands(Fast Read/Write,EAS)	ISO15693 commands, Custom commands (Kill, Fast Read/Write, EAS)	ISO15693 commands, Custom commands (Fast Read/Write)		
Input capacitance	24pF/96pF				
Serial interface	-			SPI	
Data retention	10 years (+85°C)				
Read/Write endurance	10 ¹² times				
Shipping Form	Sawn wafer (Plating bump, Backwrapped up to 150um)			Package QFN-24	
Fail Die detection	MAP (.xml format), Bad Mark (option)			-	

Target Applications and Advantage of FerVID family



Advantage

- Medical → Detailed Traceability
- Logistics → Improved Accuracy and Efficiency
- · Farm → Improved Productivity
- Factory → Improved Throughput

- Infrastructure → Monitoring of Degradation
- Transportation → Speed-up of Maintenance
- Retail → Optimal Inventory Control

FerVID family Production Roadmap

